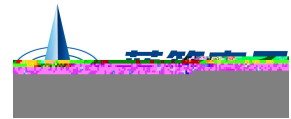


MBRD20200CT



DATA SHEET

/ Revised record

[illegible]

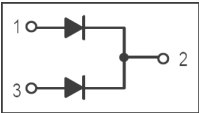
/ Descriptions

TO-252

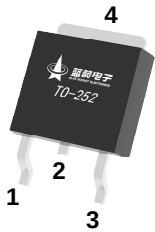
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



: :

/ Marking

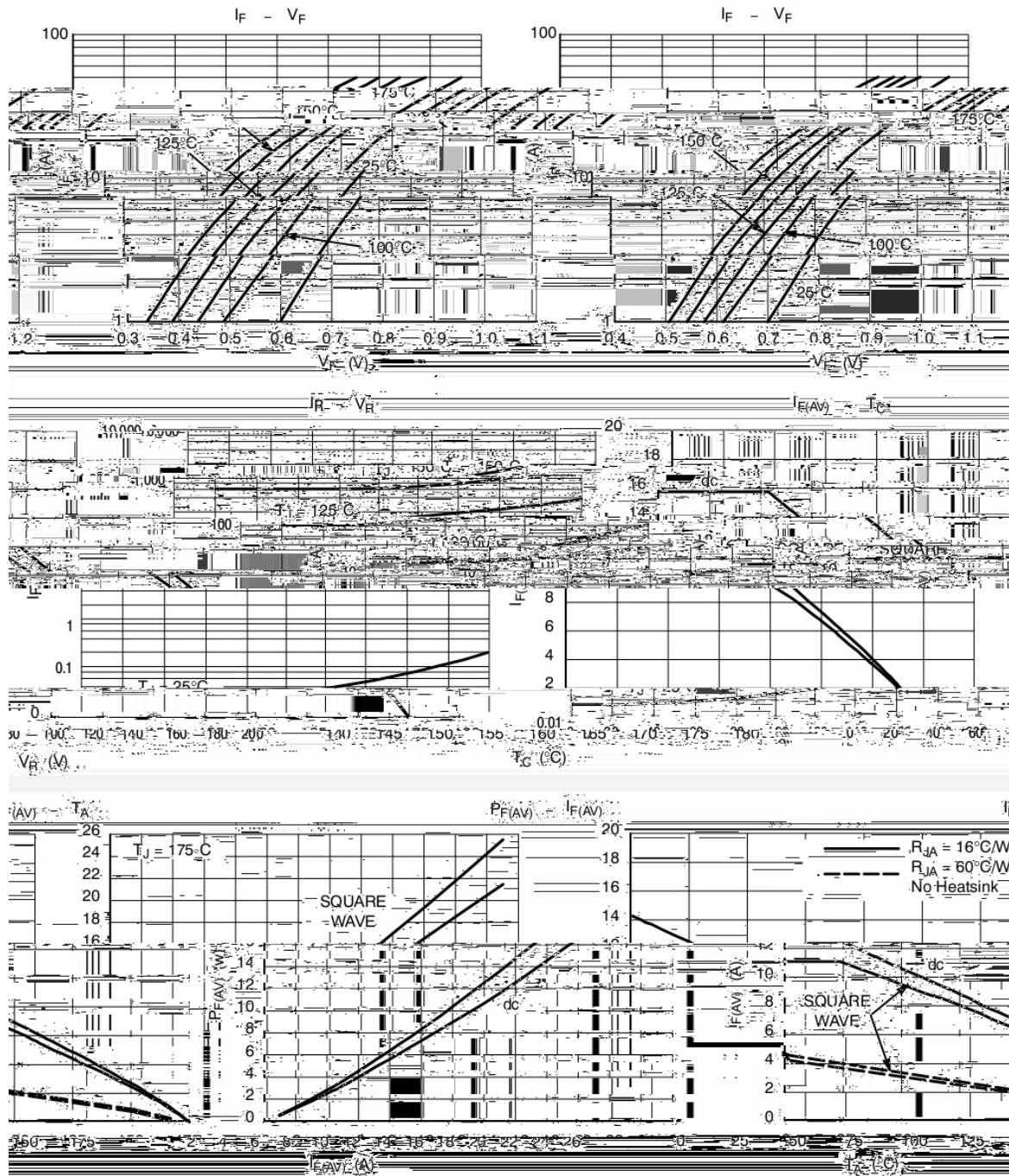
/ Absolute Maximum Ratings(Ta=25)

	()		
			℃
			℃
		~	℃

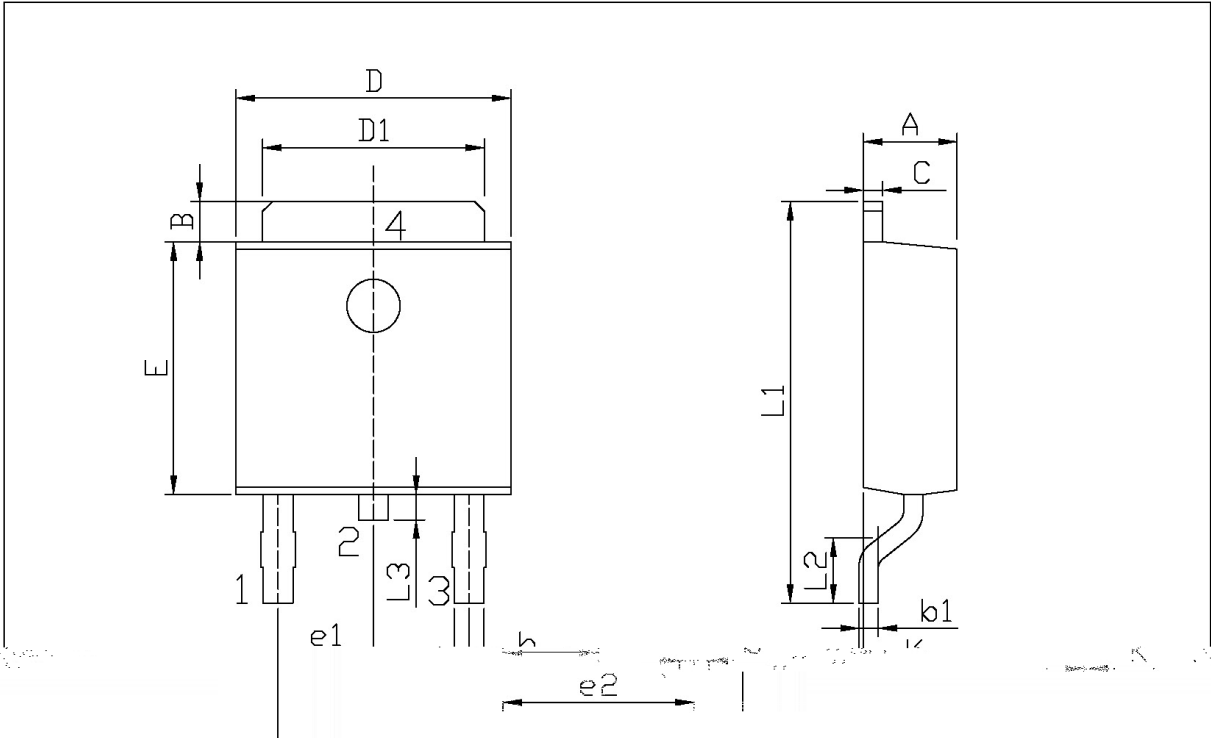
/ Electrical Characteristics(Ta=25)

		℃				
		℃				
		℃				
		℃				
		℃				
		℃				

/ Electrical Characteristic Curve



/ Package Dimensions

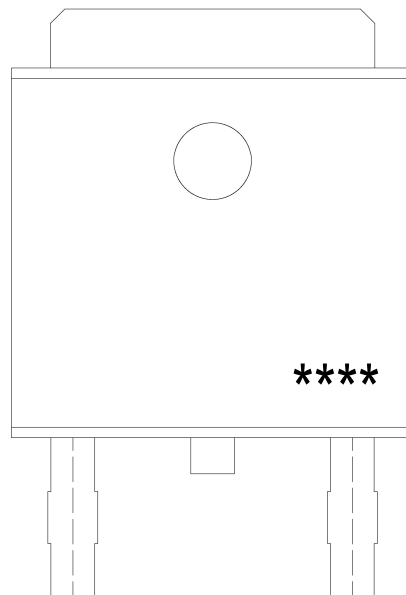


单位: mm

Symbol	Max	Min	Symbol	Max	Min
A	2.40	2.30	e1	2.24	2.14
B	0.95	0.85	e2	4.43	4.33
b	0.50	0.40	D1	9.45	9.35
b1	0.45	0.35	D	6.45	6.35
L1	0.75	0.65	L3	0.60	0.50
L2	0.55	0.45	K	0.00	0.10
L3	0.60	0.50			
K	0.00	0.10			

TO-252

/ Marking Instructions



BR
MBRD20200
CT:

() / Temperature Profile for IR Reflow Soldering(Pb-Free)

说明：

- 、预热温度 ~ °C，时间 ~ °C
- 、峰值温度 ± °C，时间持续为 ± ± °C ±
- 、焊接制程冷却速度为 ~ °C °C

/ Resistance to Soldering Heat Test Conditions

温度： ± °C 时间： ± °C

/ Packaging SPEC.

卷盘包装

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
TO-252	2,500	2	5,000	6	30,000	13" ×16	360×360×50	380×335×366

套管包装

封装形式	包装数量					包装尺寸		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-251/252	75	48	3,600	5	18,000	526×20.5×5.25	555×164×50	575×290×180

/ Notices